(   ) Preliminary Specifications
(V) Final Specifications

Module	10.1"(10.01") WXGA 16:10 Color TFT-LCD with LED Backlight design
Model Name	B101EVT04.0 (H/W: 0A)
Note (💡)	*LED Backlight without driving circuit design*

Customer	Date		Approved by	Date
			Trista Jiang	05/11/2012
Checked & Approved by	**Date**		**Prepared by**	
			Sheldon Hsu	05/11/2012
Note: This Specification is subject to change without notice.			**MPBU Marketing Division** **AU Optronics corporation**	

Product Specification

AU OPTRONICS CORPORATION

Contents

Record of Revision

Version and Date	Page	Old description	New Description	Remark
1.0 05/11/2012			1st version	

1. Handling Precautions

1) Since front polarizer is easily damaged, pay attention not to scratch it.

2) Be sure to turn off power supply when inserting or disconnecting from input connector.

3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.

4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.

5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.

6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.

7) Do not open nor modify the Module Assembly.

8) Do not press the reflector sheet at the back of the module to any directions.

9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.

11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.

12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.

13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.

2. General Description

B101EVT04.0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:10 WXGA, 1280(H) x800(V) screen and 262k colors (RGB 6-bits data driver) without LED backlight driving circuit. All input signals are LVDS interface compatible.

B101EVT04.0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 ℃ condition:

Items	Unit	Specifications		
Screen Diagonal	[mm]	255.85 (10.01W")		
Active Area	[mm]	216.96(H) x 135.6(V)		
Pixels H x V		1280 x 3(RGB) x 800		
Pixel Pitch	[mm]	0.1695 X 0.1695		
Pixel Format		R.G.B. Vertical Stripe		
Display Mode		MVA, Normally Black		
White Luminance (I_{LED}=19mA) **(Note: I_{LED} is LED current)**	[cd/m^2]	Base panel level: 350 typ. (5 points average) 300 min. (5 points average) Total Solution: 300 typ (5 points average)		
Luminance Uniformity		1.25 max. (5 points) 1.5　max (13 points)		
Contrast Ratio		1300 typ, 1000 min.		
Response Time	[ms]	25 typ / 35 Max		
Nominal Input Voltage VDD	[Volt]	+3.3 typ.		
Power Consumption	[Watt]	Base Panel: 3.1 max. (Include Logic and Blu power) Total Solution: 3.5 max		
Weight	[Grams]	135g max.(Panel only) 265g max (Total Solution)		
Physical Size (panel only) **without bracket**	[mm]		Min.	Typ.	Max.
		Length	228.96	229.46	229.96
		Width	148.7	149.2	149.7
		Thickness	---	---	2.4 (Panel Side) 4,4 (PCBA Side)

Total solution [Note: Cover lens include AS coating]	[mm]		Min.	Typ.	Max.
		Length	253.70	253.80	253.90
		Width	166.54	166.64	166.74
		Thickness	---	---	4.1 (Panel Side) 6.1 (PCBA Side)
Electrical Interface		1 channel LVDS			
Glass Thickness	[mm]	0.25			
Surface Treatment(panel only)		Anti-Reflection≦1.5%, Hardness 3H			
Support Color		262K colors (RGB 6-bit)			

Temperature Range
  Operating
  Storage (Non-Operating)
	[^{o}C]
	[^{o}C]
		-20 to +60
		-30 to +70			

RoHS Compliance		RoHS Compliance			

2.2 General Touch Specification

Item	Spec	Unit
Type of Touch Sensor	Projective Capacitive (OGS)	
Panel Size	10.1'	
Outline Dimension	253.80 X 166.64 typ	mm
Total Thickness	0.95 Typ	mm
Total Weight	120 (max)	g
TP Active Area	217.91 X 136.60 typ	mm
Interface	I2C	
Report Rate	One Finger – 150Hz	Hz
	Ten Fingers – 80Hz	
Multi-Touch Point	10 points	
Input method	Finger	
Touch panel sensor IC	ATMEL (MXT1386E)	
Channel	42 x 30	
Distance between 2 point	10 (min)	mm
Surface hardness	8	H
TP F/W version	1.0.AB	

2.3 Base Panel Optical Characteristics

The base panel optical characteristics are measured under stable conditions at 25℃ (Room Temperature) :

Item		Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
White Luminance I_{LED}=19mA			5 points average	300	350	---	cd/m²	1, 4, 5.
Viewing Angle		θ_R	Horizontal (Right)	80	85	---	degree	4, 9
		θ_L	CR = 10 (Left)	80	85	---		
		ψ_H	Vertical (Upper)	80	85	---		
		ψ_L	CR = 10 (Lower)	80	85	---		
Luminance Uniformity		δ_{5P}	5 Points	---	---	1.25		1, 3, 4
Luminance Uniformity		δ_{13P}	13 Points	---	---	1.50		2, 3, 4
Contrast Ratio		CR		1000	1300	-		4, 6
Cross talk		%		---	---	4		4, 7
Response Time		T_{RT}	Rising + Falling	---	25	35	msec	4, 8
Color / Chromaticity Coordinates	Red	Rx	CIE 1931	0.549	0.579	0.609		4
		Ry		0.308	0.338	0.368		
	Green	Gx		0.295	0.325	0.355		
		Gy		0.53	0.56	0.59		
	Blue	Bx		0.122	0.152	0.182		
		By		0.105	0.135	0.165		
	White	Wx		0.280	0.313	0.340		
		Wy		0.290	0.329	0.350		
NTSC		%		-	45	-		

Note 1: 5 points position (Ref: Active area)
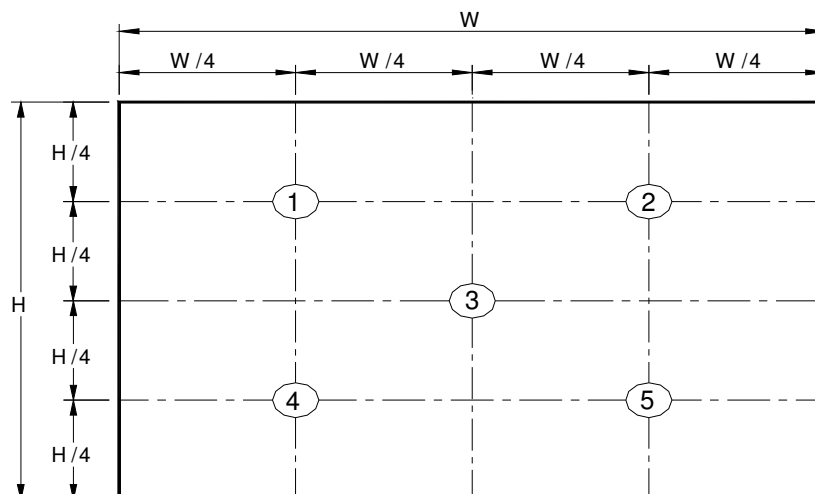
**Note 2**: 13 points position (Ref: Active area)
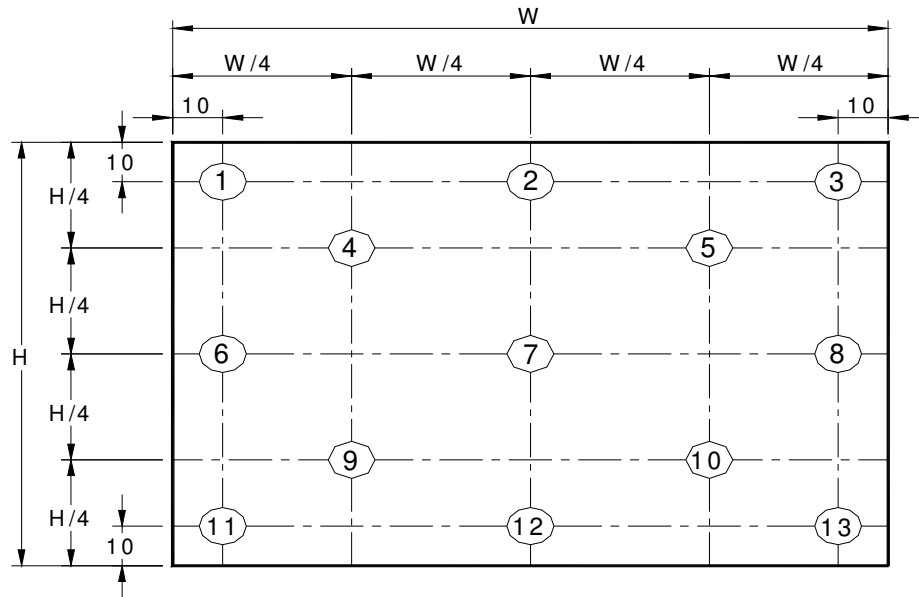
Note 3: The luminance uniformity of 5 or13 points is defined by dividing the maximum luminance values by the minimum test point luminance

$$\delta_{W5} = \frac{\text{Maximum Brightness of five points}}{\text{Minimum Brightness of five points}}$$

$$\delta_{W13} = \frac{\text{Maximum Brightness of thirteen points}}{\text{Minimum Brightness of thirteen points}}$$

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change

during measuring. In order to stabilize the luminance, the measurement should be executed after lighting

Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.
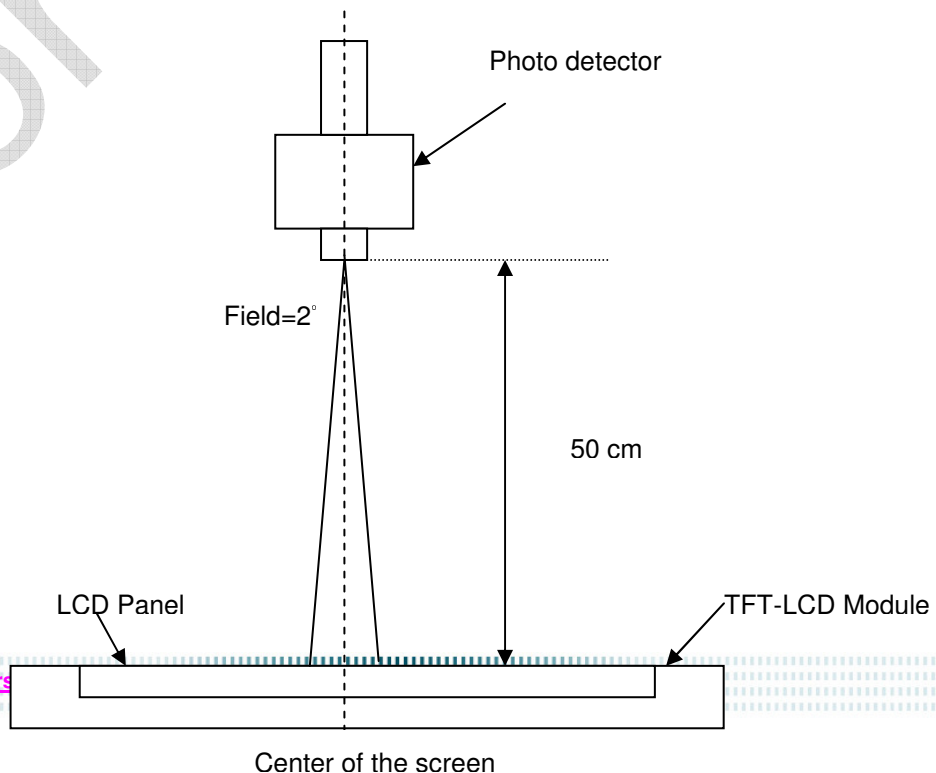
Note 5： Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points，$Y_L = [L (1)+ L (2)+ L (3)+ L (4)+ L (5)] / 5$

L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6： Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Brightness on the "White" state}}{\text{Brightness on the "Black" state}}$$

Note 7： Definition of Cross Talk (CT)

$$CT = | Y_B - Y_A | / Y_A \times 100 \ (\%)$$

Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m2)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m2)
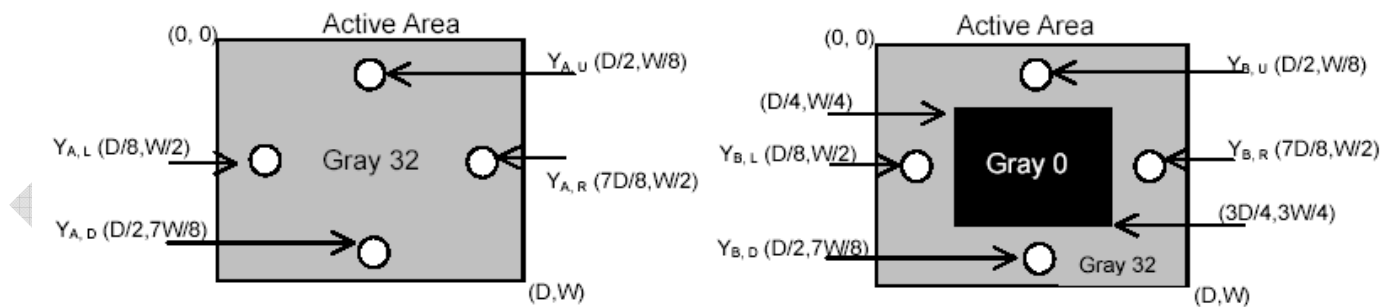
Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.
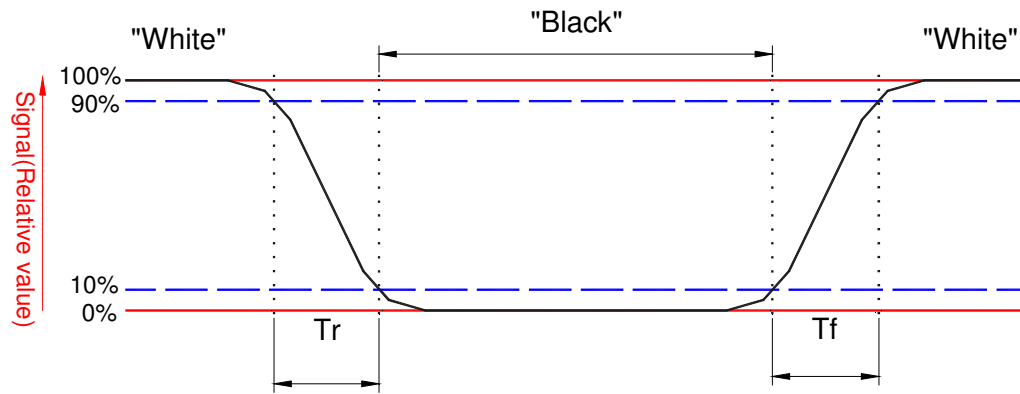
Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio ≥ 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.
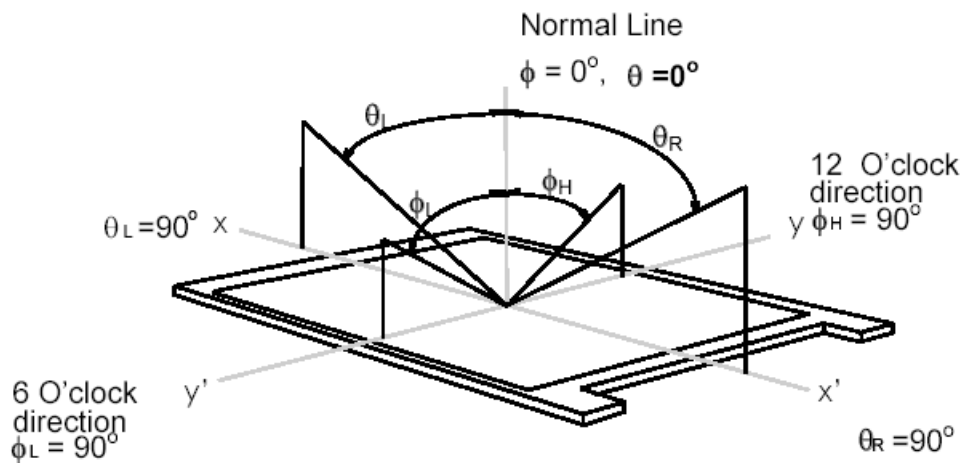
3. Functional Block Diagram

The following diagram shows the functional block of the 10.1 inches wide Color TFT/LCD 40 Pin one channel Module
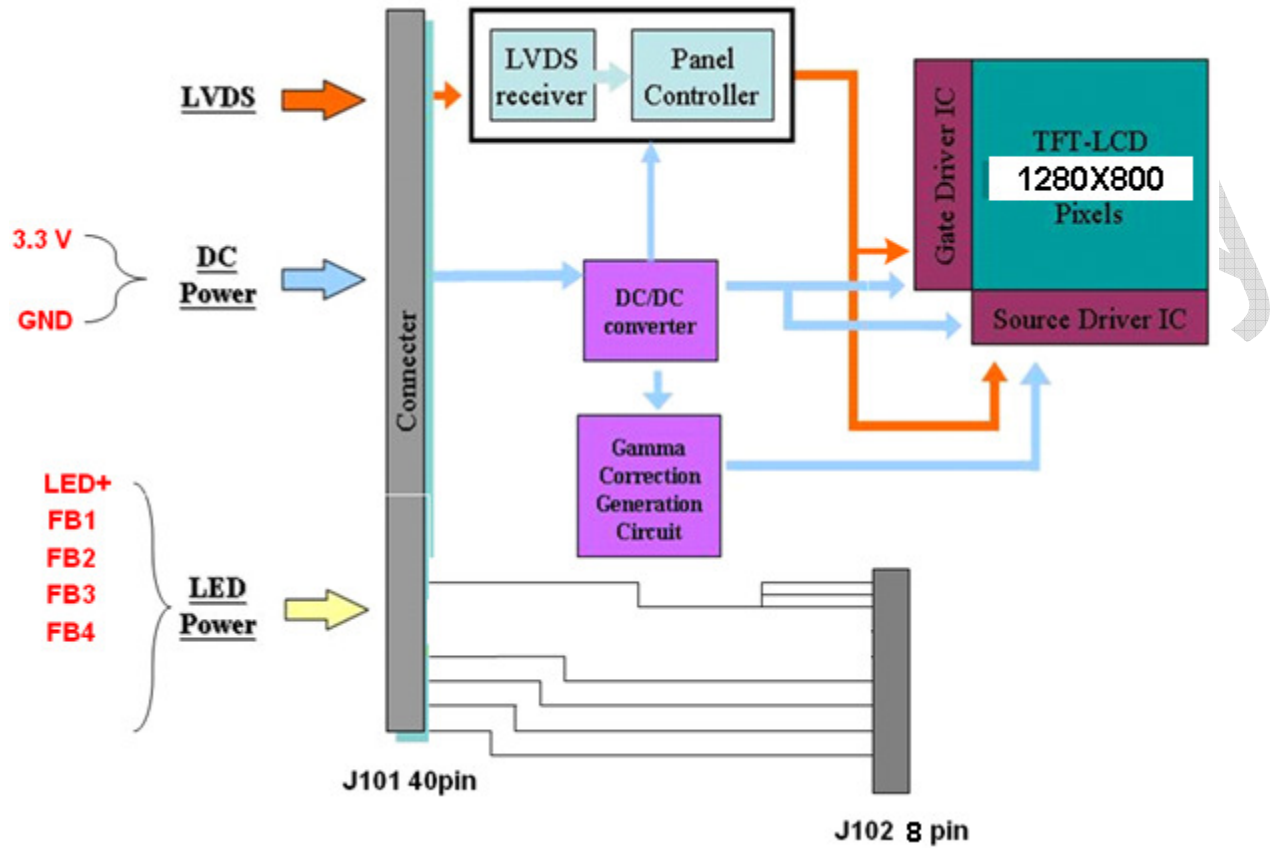
4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Touch Sensor

Item	Symbol	Min	Max	Unit	Conditions
Touch Sensor Power Voltage	Vin	4.5	5.5	[Volt]	

4.3 Absolute Ratings of Environment

Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	-20	+60	[^{o}C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-30	+70	[^{o}C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25℃)
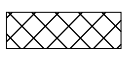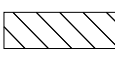
Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).
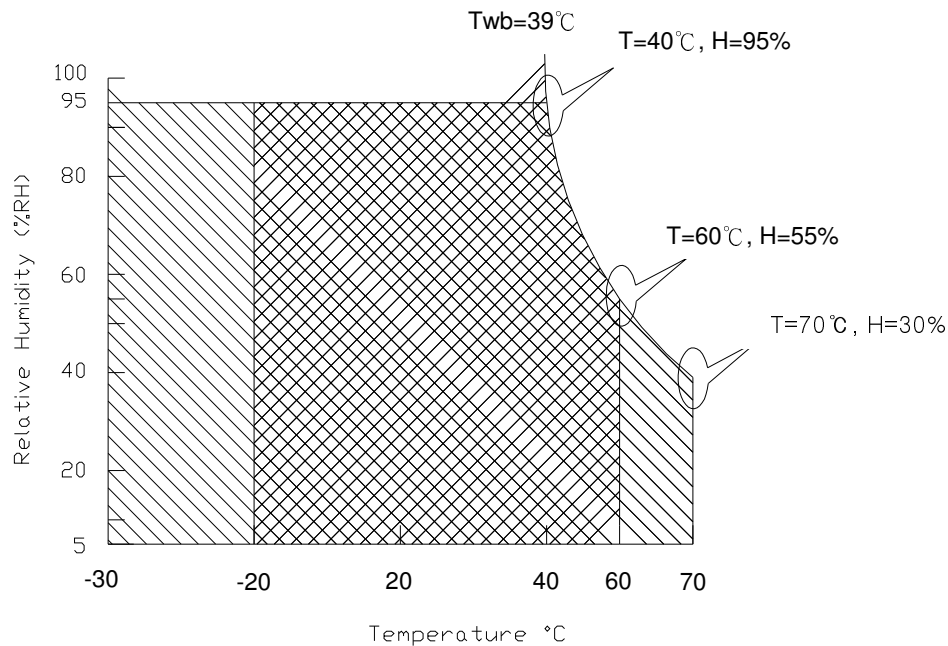
Operating Range ▨▨▨   Storage Range   ▨▨▨ + ▧▧▧

5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as follows;

The power specification are measured under 25℃ and frame frenquency under 60Hz

Symble	Parameter	Min	Typ	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	0.75	[Watt]	Note 1
IDD	IDD Current	-	-	228	[mA]	Note 1
IRush	Inrush Current	-	-	1500	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition：White Pattern at 3.3V driving voltage. ($P_{max}=V_{3.3}$ x I_{white})

Note 2：Measure Condition
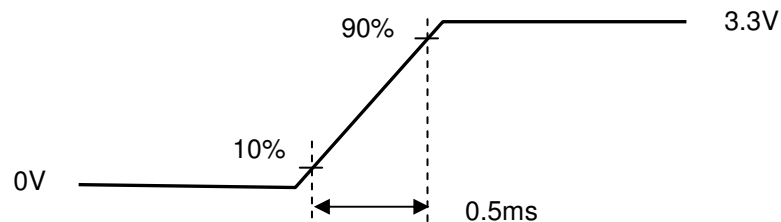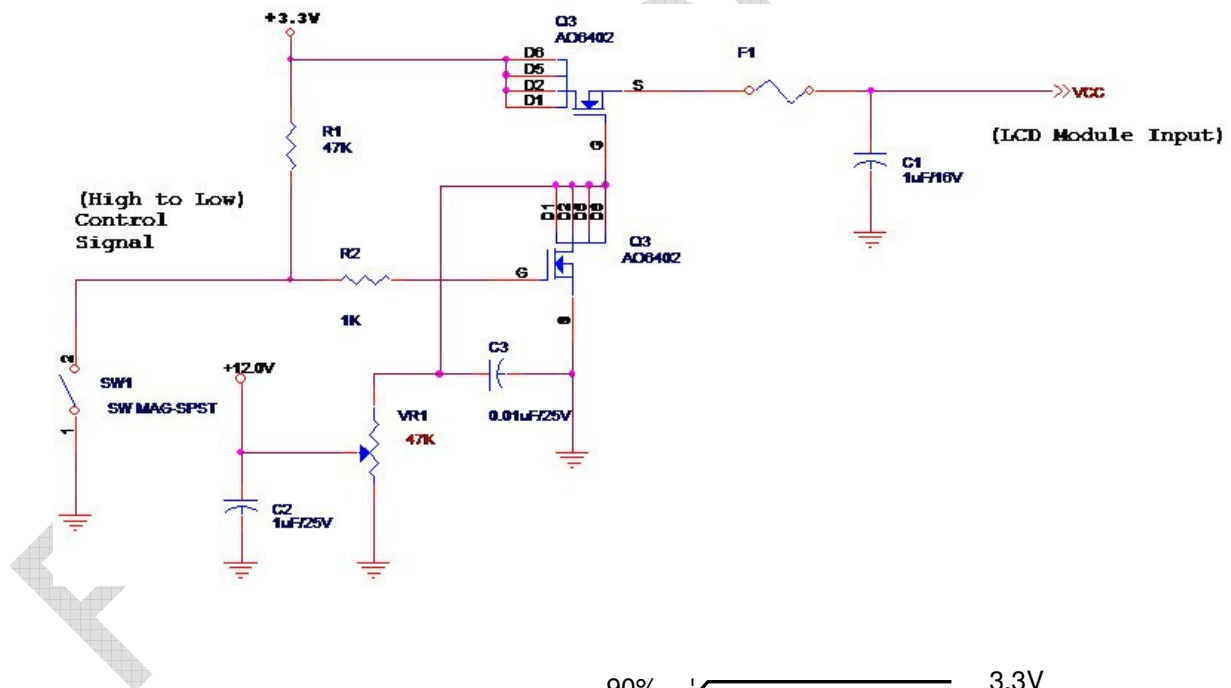
Vin rising time

5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V_{TH}	Differential Input High Threshold (Vcm=+1.2V)	---	100	[mV]
V_{TL}	Differential Input Low Threshold (Vcm=+1.2V)	-100	----	[mV]
$|V_{ID}|$	Differential Input Voltage	100	600	[mV]
V_{CM}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform
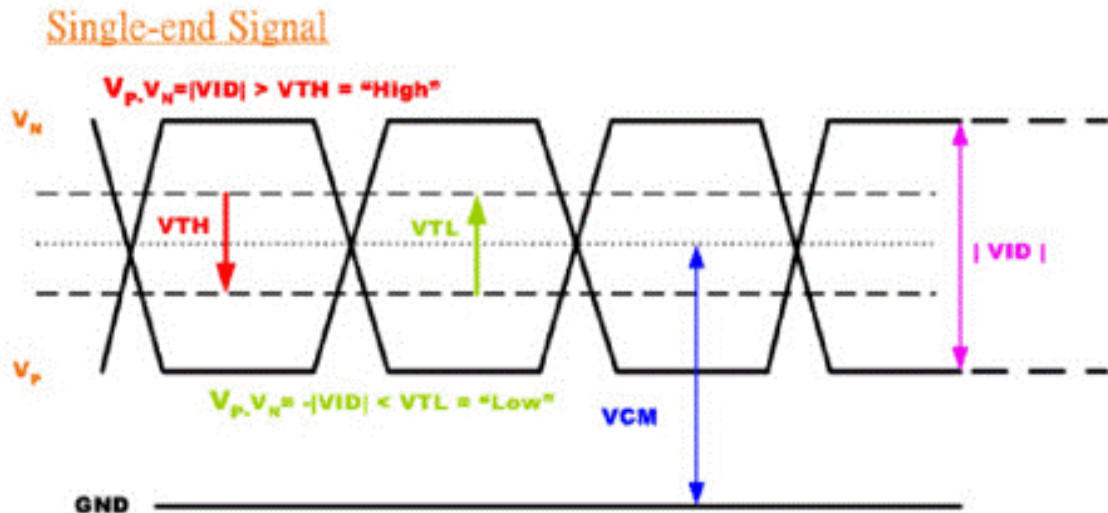
5.1.3 Dynamic contrast ratio Characteristics

Parameter	Symbol	Min	Typ	Max	Units	Remark
DCR_EN **Input High Level**	**DCR_EN**	2.5	--	3.6	[Volt]	
DCR_EN **Input Low Level**		--	--	0.65	[Volt]	
PWM_IN **Input Frequecy**	**PWM_IN**	190	200	210	[Hz]	
PWM_IN **Input High Level**		2.5	--	3.6	[Volt]	
PWM_IN **Input Low Level**		--	--	0.65	[Volt]	
Input Duty Cycle		5	--	100	%	
PWN_OUT **Output Frequency**	**PWM_OUT**	700	1K	2K	[Hz]	
PWN_OUT **Output Voltage High Level**		2	--	--	[Volt]	Note1
PWN_OUT **Output Voltage Low Level**		--	--	0.5	[Volt]	
PWM_OUT Output Duty Cycle		5		100	%	**DCR_EN disable**
PWM_OUT Output Duty Cycle		TBD*		100	%	**DCR_EN enable**

* Min. PWM_Out_Duty_Cycle = Min._System_Input_PWM_Duty * Min._DCR_Efficency.

Ex. If Min._System_Input_PWM_Duty=5% and Min._DCR_Efficency=70%, Min.

PWM_Out_Duty_Cycle=3.5%

Note1: There are a serious resistor 3.3K ohm between Tcon I/O and LVDS connector.

5.2 Backlight Unit

5.2.1 LED characteristics

Parameter	Symbol	Min	Typ	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	2.35	[Watt]	(Ta=25℃)
LED Life-Time	N/A	10,000	-	-	Hour	(Ta=25℃) Note1.
LED Forward Voltage	VF	-	3.0	3.3	[Volt]	(Ta=25℃)
LED Forward Voltage of every LED string	VF-string	-	30	33	[Volt]	(Ta=25℃) Note2.
LED Forward Current	IF	-	19	-	[mA]	(Ta=25℃)

Note 1. The LED life-time define as the estimated time to 50% degradation of initial luminous.

Note 2. Every LED string consists of 10 pcs LED chip

5.3 Touch Sensor Power Consumption

Items	Symbol	Specifications			Unit	Notes
		Min.	Typ.	Max.		
Touch Panel Power Supply	VDD	4.5	5.0	5.5	V	
Touch Panel Power Supply Current	VDDi	---	---	TBD	mA	

6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.
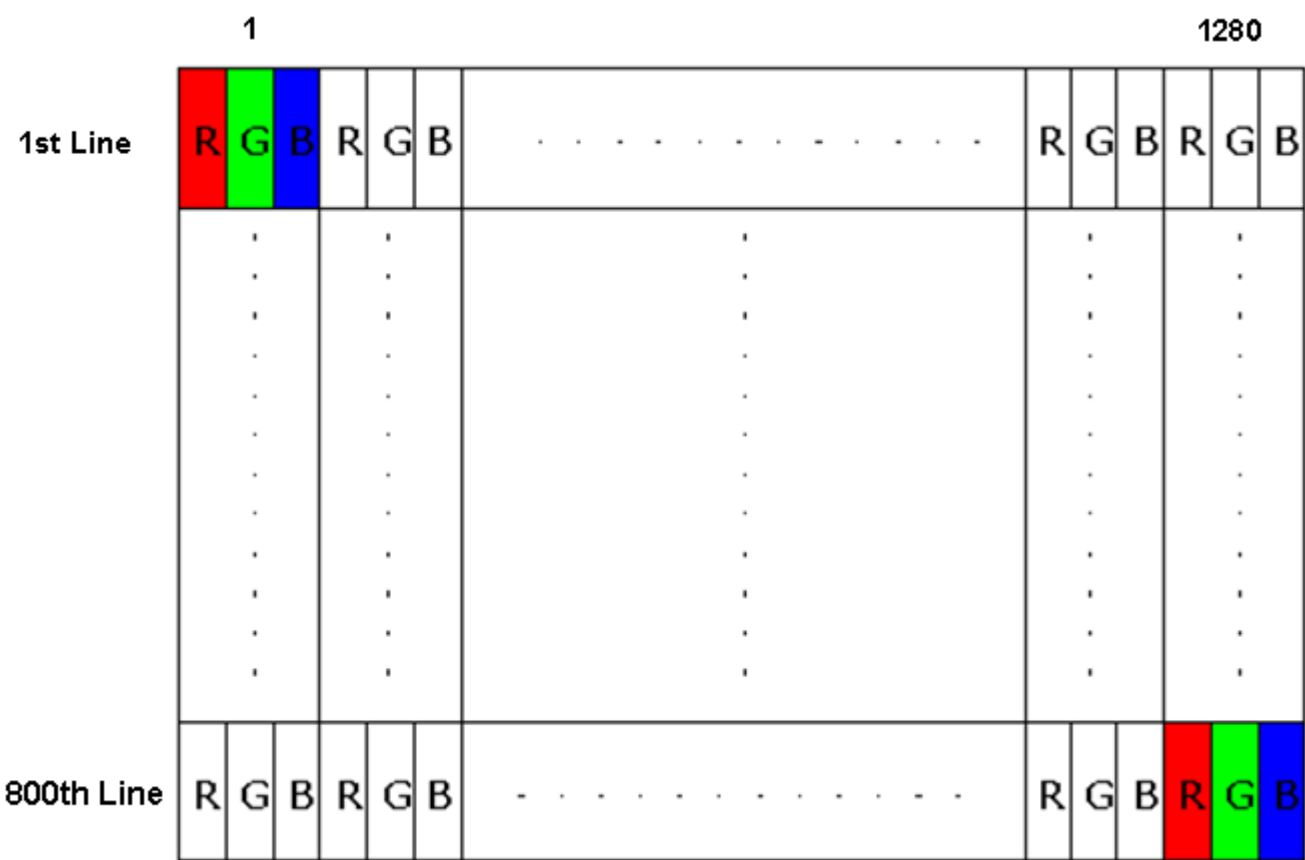
6.2 The Input Data Format
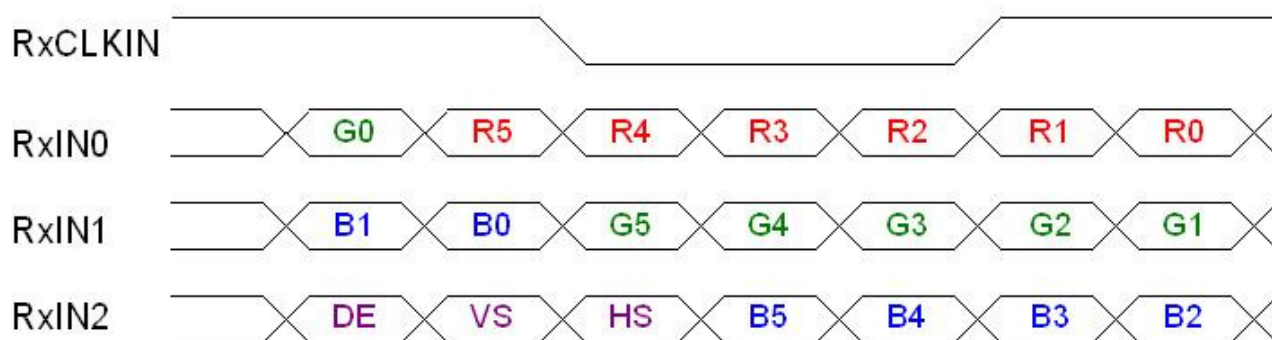
Signal Name	Description	
R5 R4 R3 R2 R1 R0	Red Data 5 (MSB) Red Data 4 Red Data 3 Red Data 2 Red Data 1 Red Data 0 (LSB) Red-pixel Data	Red-pixel Data Each red pixel's brightness data consists of these 6 bits pixel data.
G5 G4 G3 G2 G1 G0	Green Data 5 (MSB) Green Data 4 Green Data 3 Green Data 2 Green Data 1 Green Data 0 (LSB) Green-pixel Data	Green-pixel Data Each green pixel's brightness data consists of these 6 bits pixel data.
B5 B4 B3 B2 B1 B0	Blue Data 5 (MSB) Blue Data 4 Blue Data 3 Blue Data 2 Blue Data 1 Blue Data 0 (LSB) Blue-pixel Data	Blue-pixel Data Each blue pixel's brightness data consists of these 6 bits pixel data.
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and DE signals. All pixel data shall be valid at the falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of RxCLKIN. When the signal is high, the pixel data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN .
HS	Horizontal Sync	The signal is synchronized to RxCLKIN .

Note: Output signals from any system shall be low or High-impedance state when VDD is off.

6.3 Integration Interface Requirement

6.3.1 LVDS Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX
Type / Part Number	20455-040E-12R
Mating Housing/Part Number	IPEX 20453-040T-11 or compatible

6.3.2 LVDS Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

	Signal Name	Description
1	NC	No Connection (Reserve)
2	AVDD	Power Supply +3.3V
3	AVDD	Power Supply +3.3V
4	VEDID	EDID +3.3V Power
5	NC	No Connection (Reserve)
6	CLK_EDID	EDID Clock Input
7	DAT_EDID	EDID Data Input
8	Rin0-	-LVDSdifferential data input(R0-R5,G0)
9	Rin0+	+LVDSdifferential data input(R0-R5,G0)
10	GND	Ground
11	Rin1-	-LVDSdifferential data input(G1-G5,B0-B1)
12	Rin1+	+LVDSdifferential data input(G1-G5,B0-B1)
13	GND	Ground
14	Rin2-	-LVDSdifferential data input(B2-B5,HS,VS,DE)
15	Rin2+	+LVDSdifferential data input(B2-B5,HS,VS,DE)
16	GND	Ground
17	ClkIN-	-LVDSdifferential clock input
18	ClkIN+	+LVDSdifferential clock input
19	GND	Ground–Shield
20	NC	No Connection (Reserve)
21	DCR_EN	Dynamic backlight control
22	PWM_IN	System PWM signal input for dimming
23	PWM_OUT	Panel PWM signal output system
24	NC	No Connection (Reserve)
25	NC	No Connection (Reserve)
26	NC	No Connection (Reserve)
27	NC	No Connection (Reserve)

28	NC	No Connection (Reserve)
29	NC	No Connection (Reserve)
30	NC	No Connection (Reserve)
31	LED_CA1	LED Cathode 1
32	LED_CA2	LED Cathode 2
33	LED_CA3	LED Cathode 3
34	LED_CA4	LED Cathode 4
35	NC	No Connection (Reserve)
36	NC	No Connection (Reserve)
37	NC	No Connection (Reserve)
38	VLED+	LED positive voltage
39	VLED+	LED positive voltage
40	VLED+	LED positive voltage
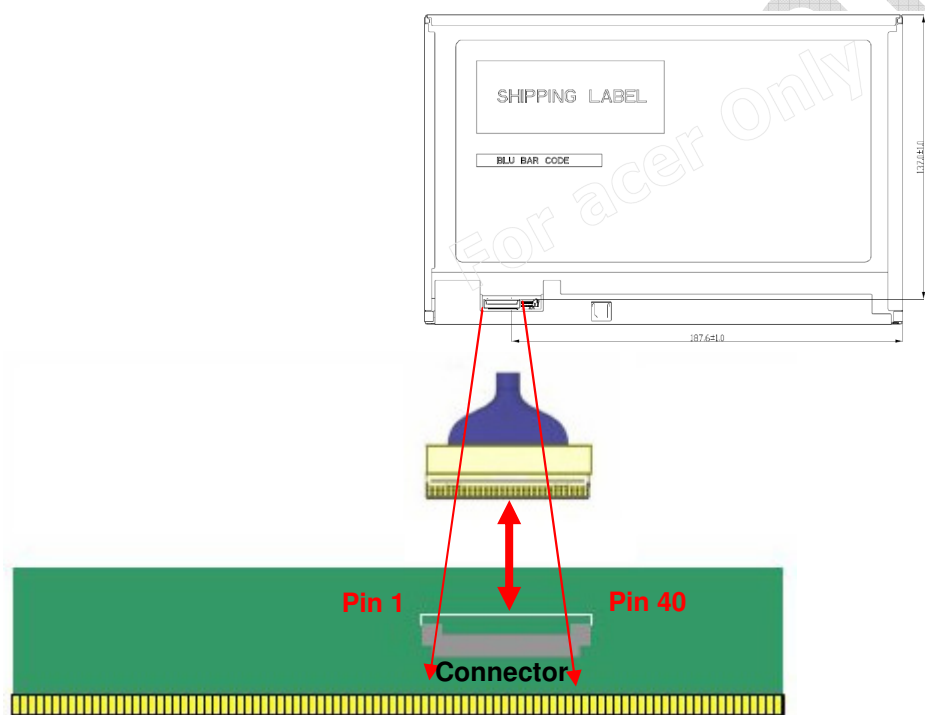
Note1: Input signals shall be low or High-impedance state when VDD is off.

6.4 Touch Sensor Pin Assignment

PIN#	Signal Name	Description
1	VDD	5V power
2	SCL	Serial Interface Clock
3	SDA	Serial Interface Data
4	CHG	State change interrupt
5	GND	Ground
6	RESET	Reset low
7	VDD	5V power
8	Enable	LDO ON/OFF
9	DEBUG DATA	Debug port data
10	DEBUG CLK	Debug port clock

6.5 LVDS Interface Timing

6.5.1 Timing Characteristics

Basically, interface timings should match the 1280x800 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Typ.	Max.	Unit
Frame Rate		**---**	---	60	---	**Hz**
Clock frequency		1/ T_{Clock}	64	68.93	85	**MHz**
Vertical Section	**Period**	T_V	808	816	1023	T_{Line}
	Active	T_{VD}		800		
	Blanking	T_{VB}	8	16	223	
Horizontal Section	**Period**	T_H	1310	1408	2047	T_{Clock}
	Active	T_{HD}		1280		
	Blanking	T_{HB}	40	168	767	

Note : DE mode only

6.5.2 Timing diagram

Input Timing Definition (DE Mode)
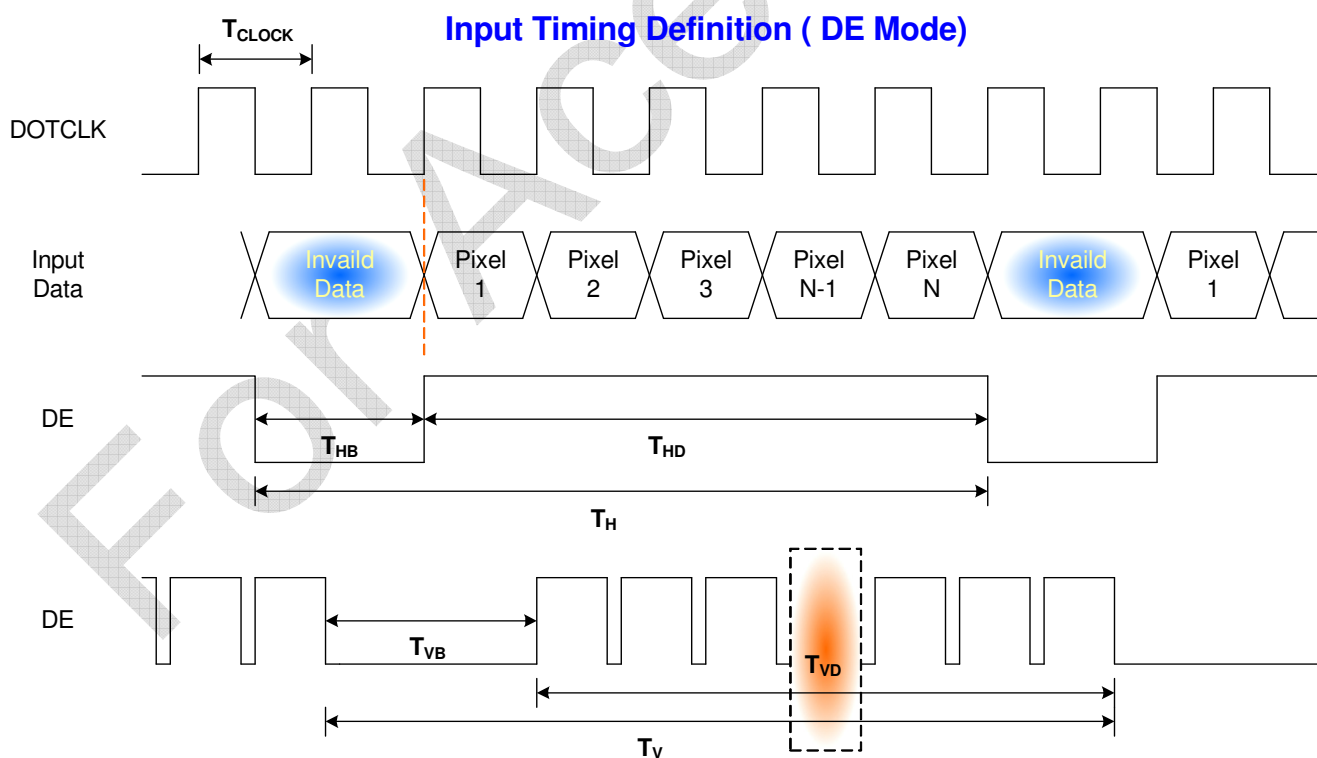
6.6 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off
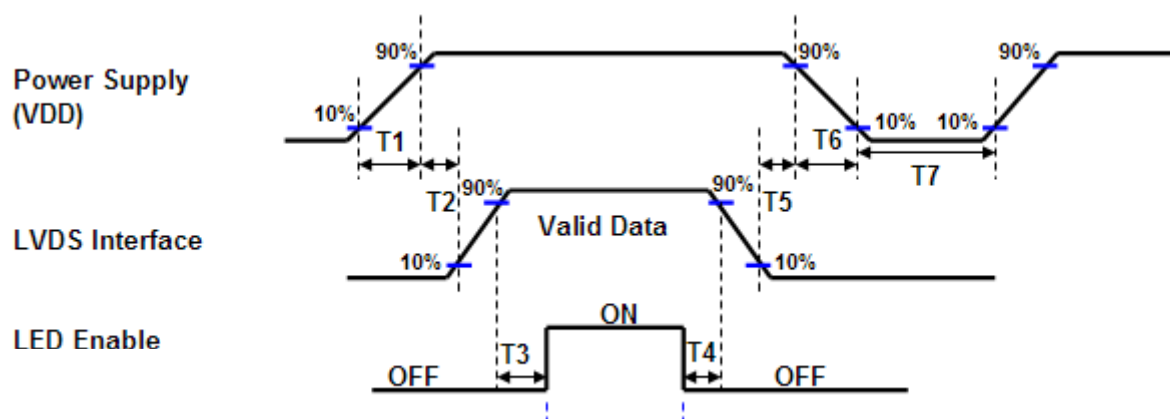
Power Sequence Timing			
	Value		
Parameter	Min.	Max.	Units
T1	0.5	10	
T2	0	50	
T3	200	-	
T4	200	-	ms
T5	0	50	
T6	0	10	
T7	500	-	

7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

- Test method:　Non-Operation
- Acceleration:　1.5 G
- Frequency:　10 - 500Hz Random
- Sweep:　　　30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

- Test method:　Non-Operation
- Acceleration:　220 G , Half sine wave
- Active time:　2 ms
- Pulse:　　　X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 240h	
High Temperature Operation	Ta= 60℃, Dry, 240h	
Low Temperature Operation	Ta=-20℃, 240h	
High Temperature Storage	Ta= 70℃, 240h	
Low Temperature Storage	Ta= -30℃, 240h	
Thermal Shock Test	Ta=-30℃ to 70℃, Duration at 30 min, 20 cycles	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

Note1: According to EN 61000-4-2 , ESD class B: Some performance degradation allowed. No data lost

　.　Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

8. Mechanical Characteristics

8.1 LCM Outline Dimension

8.1.1 Standard Front View

8.1.2 Standard Rear View

229.46(LCM OD)

(11.22)

10.21

13.12±0.30

11.90

8.50

9.52±0.30

149.20(LCM OD)

6.80

(7.92)

SHIPPING LABEL

BLU BAR CODE
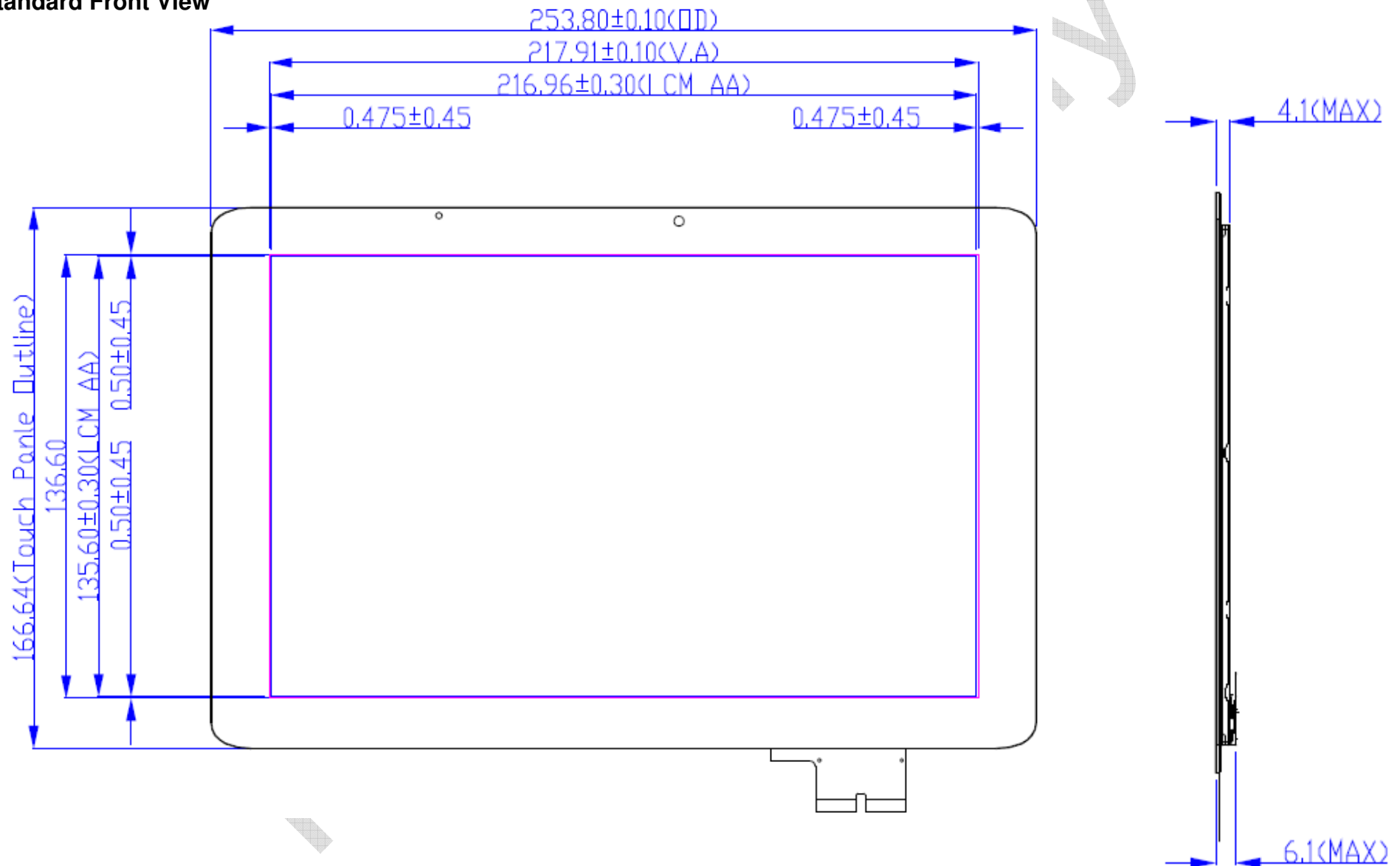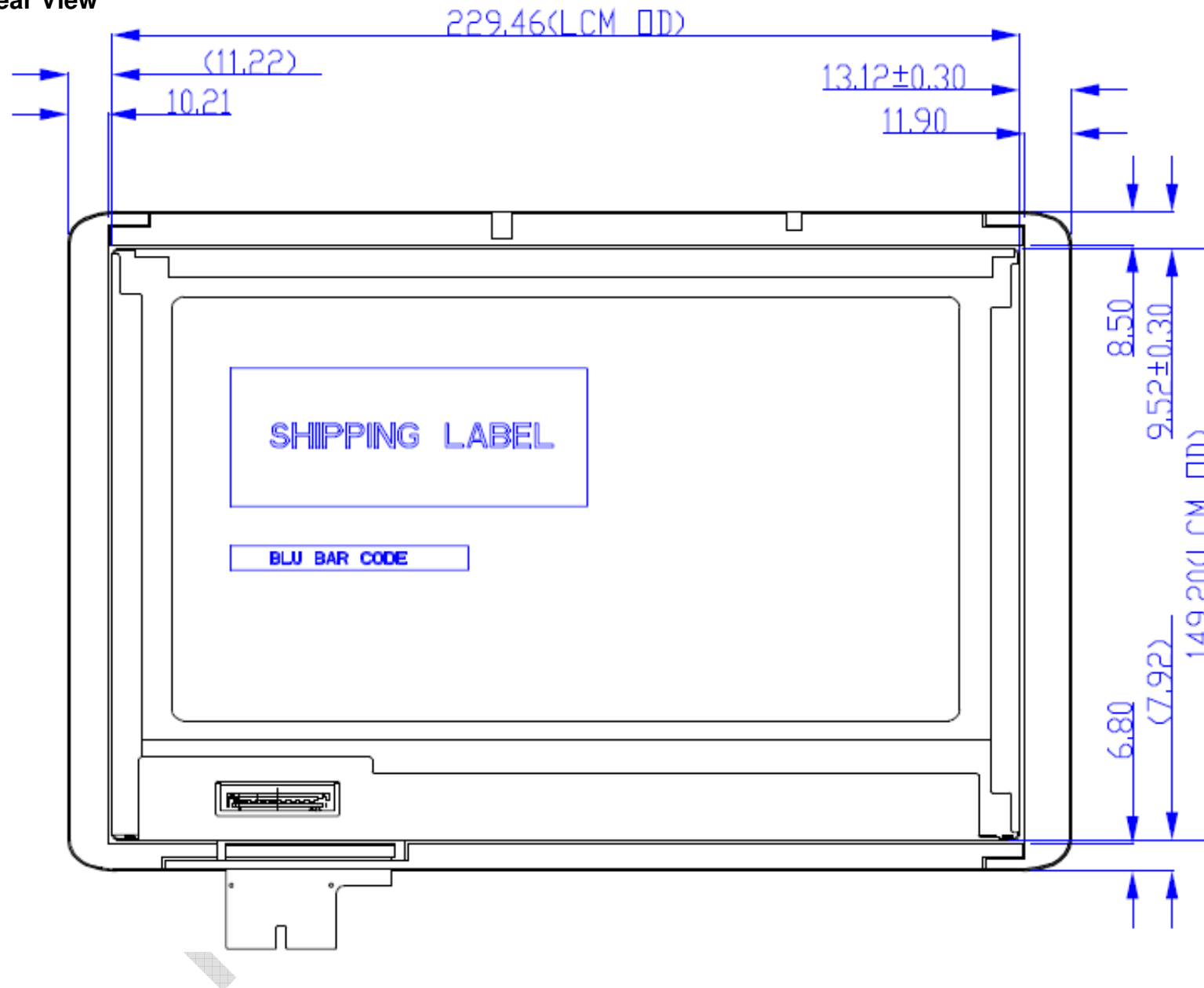
9. Shipping and Package

9.1 Shipping Label Format

Shipping Label

Manufactured YY/WW
Model No: B101EVT04.0
AU Optronics
MADE IN CHINA (S1)

c ℝᵁ us
E204356

Pb

RoHS

15

H/W: 0A F/W:0

XXXXXXXXXXX-XXXXX

9.2 Carton Label Format

Carton Label

AU Optronics   QTY：40   RoHS   Pb

MODEL NO : B101EVT04.0

PART NO : 97.10B38.000

CUSTOMER NO :

CARTON NO :

Made in China   *ZS0100-0652300205*

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9.3 Shipping Package of Palletizing Sequence
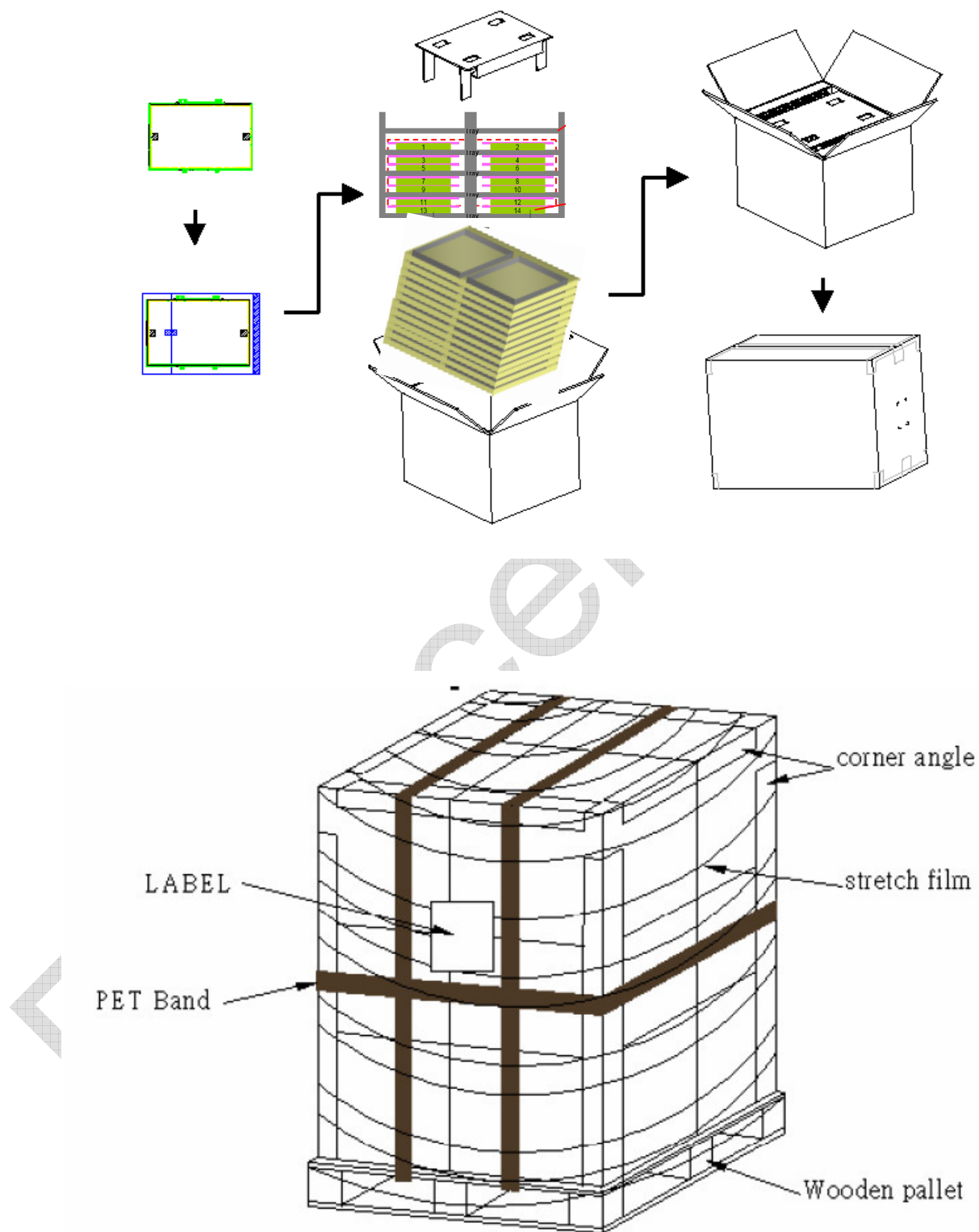
10. Appendix

10.1 EDID Description

B101EVT04 0 EDID Code

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	D4	11010100	212	
0B	hex, LSB first	40	01000000	64	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	15	00010101	21	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
14	**Video input def.** (digital I/P, non-TMDS, CRGB)	90	10010000	144	
15	**Max H image size** (rounded to cm)	16	00010110	22	
16	**Max V image size** (rounded to cm)	0E	00001110	14	
17	**Display Gamma** (=(gamma*100)-100)	78	01111000	120	
18	**Feature support** (no DPMS, Active OFF, RGB, tmg Blk#1)	02	00000010	2	
19	Red/green low bits **(Lower 2:2:2:2 bits)**	65	01100101	101	
1A	Blue/white low bits **(Lower 2:2:2:2 bits)**	25	00100101	37	
1B	Red x **(Upper 8 bits)**	94	10010100	148	
1C	Red y/ highER 8 bits	56	01010110	86	
1D	Green x	53	01010011	83	
1E	Green y	8F	10001111	143	
1F	Blue x	27	00100111	39	
20	Blue y	22	00100010	34	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	__
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	00000001	1	
28	Standard timing #2	01	00000001	1	

29		01	00000001	1	
2A	Standard timing #3	01	00000001	1	
2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D		01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	00000001	1	
32	Standard timing #7	01	00000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	D0	11010000	208	
37	Pixel Clock/10000 USB	1B	00011011	27	
38	Horz active **Lower 8bits**	00	00000000	0	
39	Horz blanking **Lower 8bits**	B8	10111000	184	
3A	HorzAct:HorzBlnk **Upper 4:4 bits**	50	01010000	80	
3B	Vertical Active **Lower 8bits**	20	00100000	32	
3C	Vertical Blanking **Lower 8bits**	08	00001000	8	
3D	Vert Act : Vertical Blanking **(upper 4:4 bit)**	30	00110000	48	
3E	HorzSync. Offset	08	00001000	8	
3F	HorzSync.Width	0A	00001010	10	
40	VertSync.Offset : VertSync.Width	31	00110001	49	
41	Horz&Vert Sync Offset/Width **Upper 2bits**	00	00000000	0	
42	Horizontal Image Size **Lower 8bits**	D8	11011000	216	
43	Vertical Image Size **Lower 8bits**	87	10000111	135	
44	Horizontal & Vertical Image Size **(upper 4:4 bits)**	00	00000000	0	
45	Horizontal Border *(zero for internal LCD)*	00	00000000	0	
46	Vertical Border *(zero for internal LCD)*	00	00000000	0	
47	Signal *(non-intr, norm, no stero, sep sync, neg pol)*	18	00011000	24	
48	Detailed timing/monitor	00	00000000	0	
49	descriptor #2	00	00000000	0	
4A		00	00000000	0	
4B		0F	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	

5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	A
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	O
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	B
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	30	00110000	48	0
74	Manufacture P/N	31	00110001	49	1
75	Manufacture P/N	45	01000101	69	E
76	Manufacture P/N	56	01010110	86	V
77	Manufacture P/N	54	01010100	84	T
78	Manufacture P/N	30	00110000	48	0
79	Manufacture P/N	34	00110100	52	4
7A	Manufacture P/N	2E	00101110	46	.
7B	Manufacture P/N	30	00110000	48	0
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	B4	10110100	180	
			SUM	6144	

SUM to HEX   1800